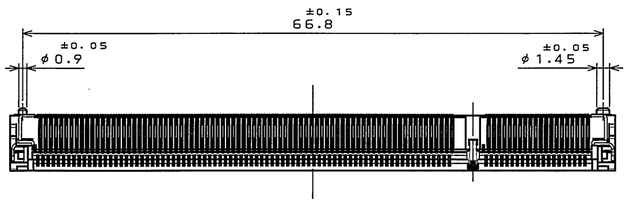
図面番号(DRAWING NO.) SJ101278

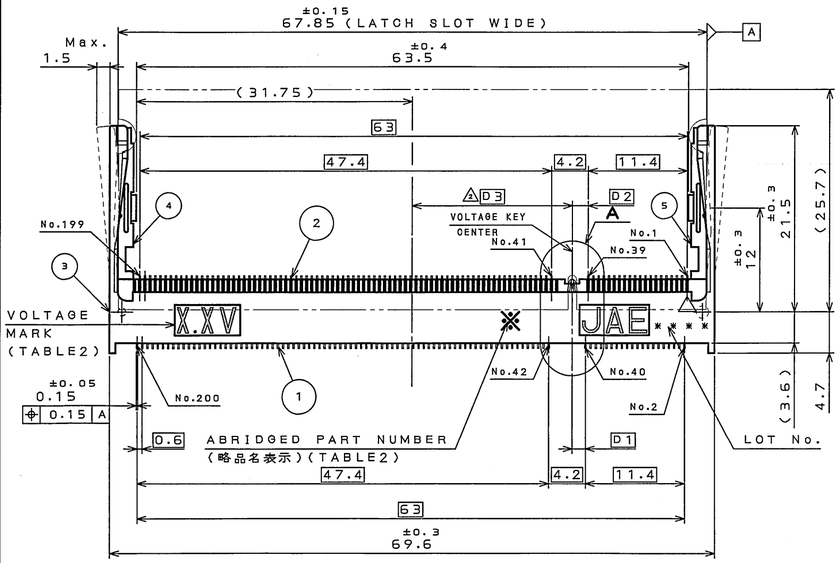
版数 REV.	年月日 DATE	DCN NO.	変更内容 DESCRIPTION	製図 DR.	担当 CHK.	査閲 APPD.	承認 APPD.
2	10.Feb.2006	059307	CORRECTION OF ERROR IN WRITTING	E.MURANO	Y.YAHIRO	—	K.Hasegawa

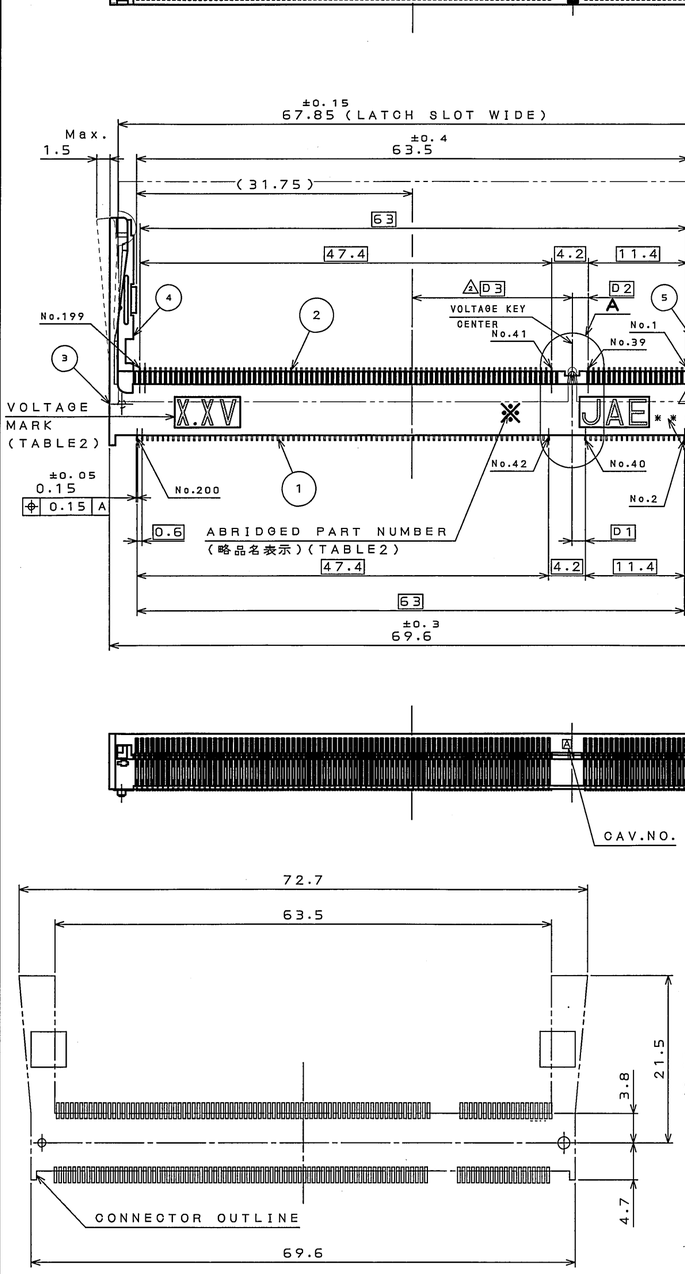
DESIGNATION

MM50-200B*-E1RE

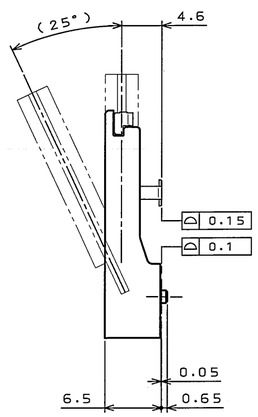
- SERIES PREFIX シリーズ名
- NO. OF CONTACTS 芯数
- SOCKET TYPE ソケットタイプ B:LATCH TYPE SMT
- KEYING TYPE(DETAIL A) キィタイプ 2:TYPE B(1.8V) 1:TYPE A(2.5V)
- CONTACT FINISH 接点仕上げ 1:Au(0.1μm MIN) OVER NI
- MODIFY CODE モディファイコード E:6.5mm HIGHT
- R :REVERSE NONE:STANDARD
- 錫または錫合金(無鉛) (LEAD FREE)TIN/TIN ALLOY







CONNECTOR MOUNTED AREA(REF.)



DETAIL A
(SCALE 5:1)
(REF.TABLE1)

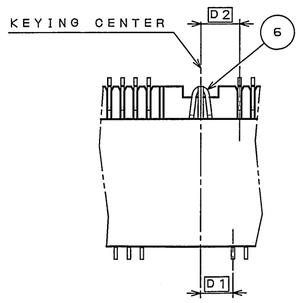
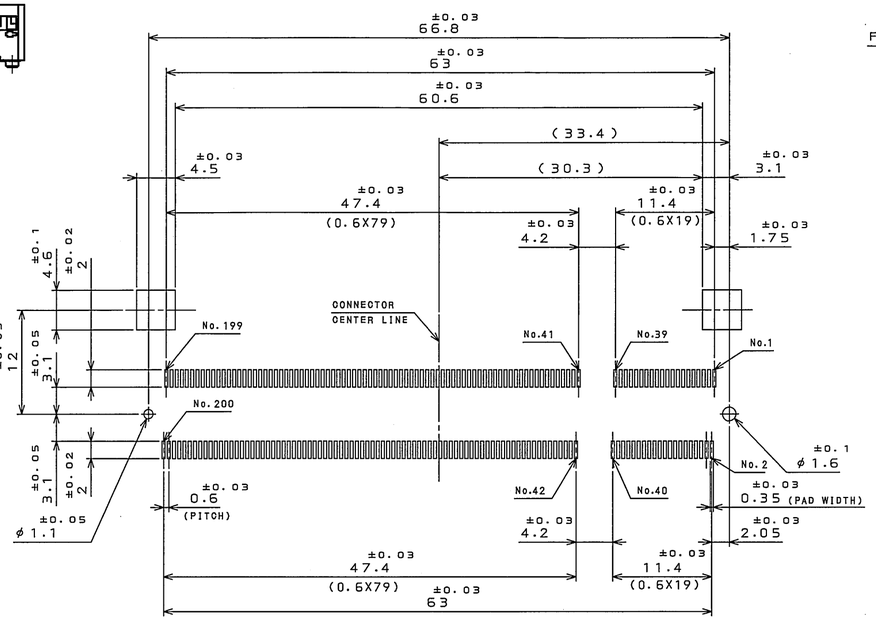


TABLE2

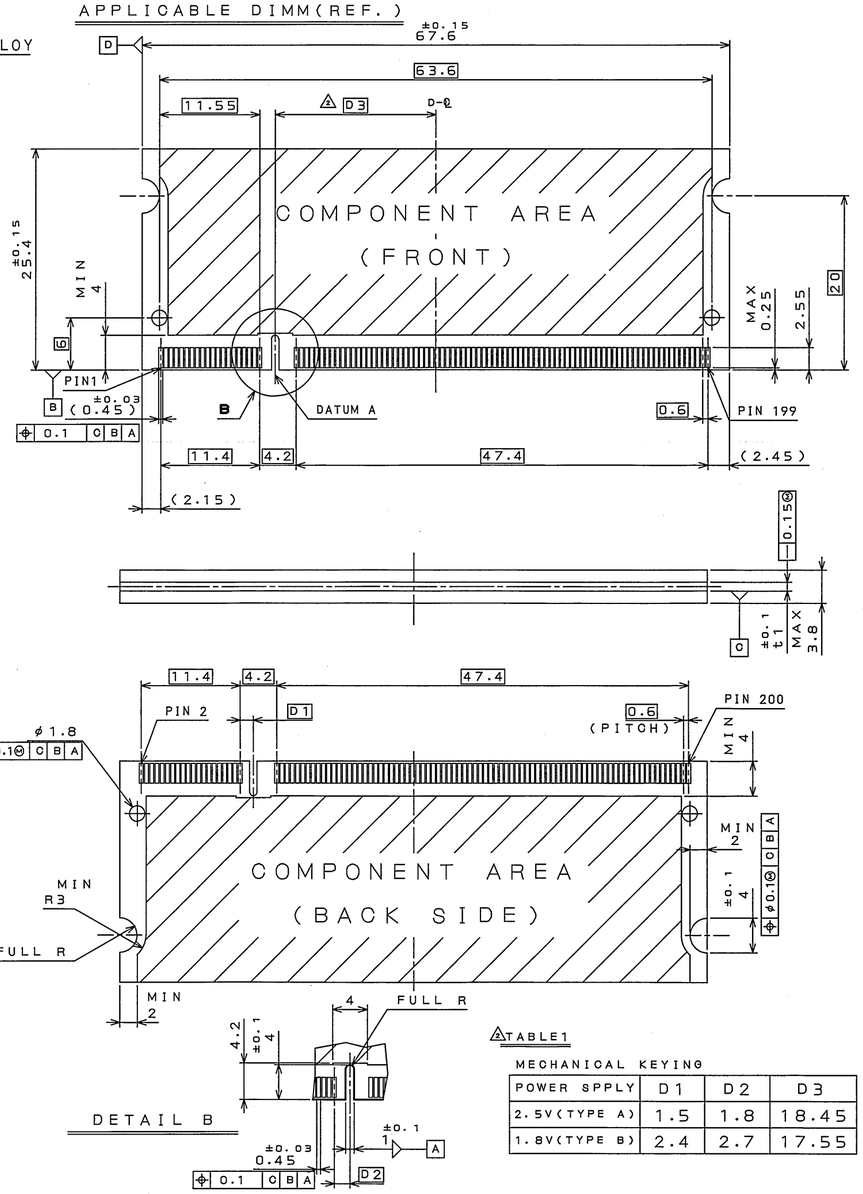
DISCRIMINATION MARK

PARTS NAME	VOLTAGE MARK	ABRIDGED PART NUMBER
MM50-200B1-E1RE	2.5V	E1RE
MM50-200B2-E1RE	1.8V	2-E1RE

APPLICABLE P.C.B. DIMENSION(REF.)
適合基板寸法(参考)



APPLICABLE DIMM(REF.)



DETAIL B

△TABLE1

MECHANICAL KEYING

POWER SPPLY	D1	D2	D3
2.5V(TYPE A)	1.5	1.8	18.45
1.8V(TYPE B)	2.4	2.7	17.55

NO.	DESCRIPTION 名称	QTY. 個数	MATERIAL 材料	FINISH 仕上	REMARKS 備考
6	KEY	1	STAINLESS	———	———
5	HOLD DOWN 2	1	PHOSPHOR BRONZE	TIN PLATING	———
4	HOLD DOWN 1	1	PHOSPHOR BRONZE	TIN PLATING	———
3	INSULATOR	1	GLASS FILLED LCP	———	UL94 V-0 COLOR WHITE
2	BOTTOM SIDE CONTACT	100	PHOSPHOR BRONZE	CONTACT AREA:Au(0.1μm MIN) OVER NI SOLDERING AREA:GOLD FLASH OVER NI	———
1	TOP SIDE CONTACT	100	PHOSPHOR BRONZE	CONTACT AREA:Au(0.1μm MIN) OVER NI SOLDERING AREA:GOLD FLASH OVER NI	———

仕様書(SPECIFICATION)	JAOS-1655-01
一般公差(GENERAL TOLERANCE)	
寸法(DIMENSION)	. ±0.8 .× ±0.4 .×× ±0.1 .××× ±
角度(ANGLES)	× ° ± ××′ ″ ±
第1版(ORIGINAL DATE)	20.May.2004
製図 DR.	———
担当 CHK.	R.KATOU
査閲 APPD.	Y.YAHIRO
承認 APPD.	S.KASHIWAGI
尺度(SCALE)	2:1
シリーズ(SERIES)	MM50
名称(TITLE)	MM50 -200B*-E1RE
質量(MASS)	

日本航空電子工業株式会社
JAPAN AVIATION ELECTRONICS INDUSTRY, LTD.

図面番号(DRAWING NO.) SJ101278

版数(REV.) 2

SIZE A2

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